



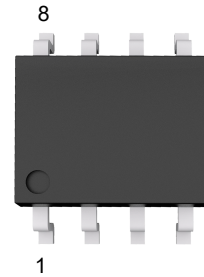
# PJM08C60PA

## N and P-Channel Complementary Power MOSFET

### Features

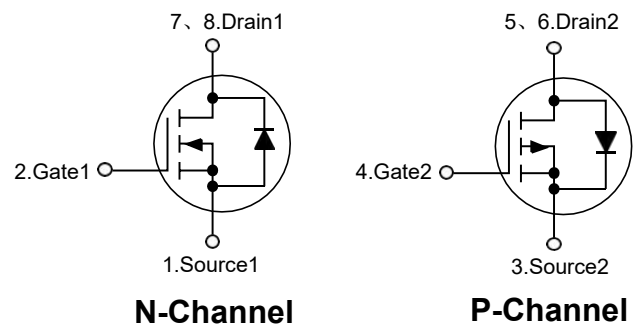
- **N-Channel**  
 $V_{DS}=60V, I_D=8A$   
 $R_{DS(on)} < 50m\Omega @ V_{GS}=10V$
- **P-Channel**  
 $V_{DS}=-60V, I_D=-8A$   
 $R_{DS(on)} < 70m\Omega @ V_{GS}=-10V$
- Low On-Resistance
- Advanced Trench Technology
- Fast Switching Speed

SOP-8



Marking Code:06C60

Schematic Diagram



### Applications

- High Power and Current Handling Capability
- Lead Free Product is Acquired
- Surface Mount Package

### Absolute Maximum Ratings

Ratings at 25°C ambient temperature unless otherwise specified.

Parameter	Symbol	N-Channel	P-Channel	Unit
Drain-Source Voltage	$V_{DS}$	60	-60	V
Gate-Source Voltage	$V_{GS}$	±20		V
Drain Current-Continuous	$I_D$	8	-8	A
Drain Current-Pulsed <sup>Note1</sup>	$I_{DM}$	40	-30	A
Maximum Power Dissipation	$P_D$	2		W
Single pulse avalanche energy <sup>Note4</sup>	$E_{AS}$	30	30	mJ
Junction Temperature	$T_J$	150		°C
Storage Temperature Range	$T_{STG}$	-55 to +150		°C

### Thermal Characteristics

Thermal Resistance, Junction-to-Ambient <sup>Note2</sup>	$R_{\theta JA}$	62.5	°C/W
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**N-Channel****Electrical Characteristics**(T<sub>J</sub>=25°C unless otherwise specified)

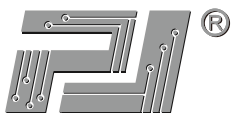
Parameter	Symbol	Test Condition	Min.	Typ.	Max.	Unit
<b>Static Characteristics</b>						
Drain-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	V <sub>GS</sub> =0V, I <sub>D</sub> =250μA	60	--	--	V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =60V, V <sub>GS</sub> =0V	--	--	1	μA
Gate-Body Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> =±20V, V <sub>DS</sub> =0V	--	--	±100	nA
Gate Threshold Voltage <sup>Note3</sup>	V <sub>GS(th)</sub>	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250μA	1	1.5	2.5	V
Drain-Source On-Resistance <sup>Note3</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =8A	--	22	40	mΩ
		V <sub>GS</sub> =4.5V, I <sub>D</sub> =8A	--	25	50	mΩ
Forward Transconductance <sup>Note3</sup>	g <sub>FS</sub>	V <sub>DS</sub> =5V, I <sub>D</sub> =2A	--	8	--	S
<b>Dynamic Characteristics</b>						
++Input Capacitance	C <sub>iss</sub>	V <sub>DS</sub> =20V, V <sub>GS</sub> =0V, f=1MHz	--	865	--	pF
Output Capacitance	C <sub>oss</sub>		--	85	--	pF
Reverse Transfer Capacitance	C <sub>rss</sub>		--	75	--	pF
Gate Resistance	R <sub>g</sub>	V <sub>DS</sub> =0V, V <sub>GS</sub> =0V, f=1MHz	--	1.1	--	Ω
<b>Switching Characteristics</b>						
Turn-on Delay Time	t <sub>d(on)</sub>	V <sub>DD</sub> =30V, R <sub>L</sub> =2.5Ω V <sub>GS</sub> =10V, R <sub>GEN</sub> =3Ω	--	7	--	nS
Turn-on Rise Time	t <sub>r</sub>		--	20	--	nS
Turn-off Delay Time	t <sub>d(off)</sub>		--	16	--	nS
Turn-off Fall Time	t <sub>f</sub>		--	23	--	nS
Total Gate Charge	Q <sub>g</sub>	V <sub>DS</sub> =30V, I <sub>D</sub> =6A, V <sub>GS</sub> =10V	--	25	--	nC
Gate-Source Charge	Q <sub>gs</sub>		--	3	--	nC
Gate-Drain Charge	Q <sub>gd</sub>		--	6.4	--	nC
<b>Source-Drain Diode Characteristics</b>						
Diode Forward Voltage <sup>Note3</sup>	V <sub>SD</sub>	V <sub>GS</sub> =0V, I <sub>S</sub> =8A	--	--	1.2	V
Diode Forward Current	I <sub>S</sub>		--	--	6	A

Note: 1. Repetitive Rating: Pulse width limited by maximum junction temperature.

2. Surface Mounted on FR4 Board, t ≤ 10 sec.

3. Pulse Test: Pulse width ≤ 300μs, duty cycle ≤ 2%.

4. EAS Condition: T<sub>J</sub>=25°C, V<sub>DD</sub>=30V, V<sub>G</sub>=10V, L=0.5mH, R<sub>G</sub>=25Ω, I<sub>AS</sub>=11A.



# PJM08C60PA

## N and P-Channel Complementary Power MOSFET

### P-Channel

#### Electrical Characteristics

( $T_J=25^{\circ}\text{C}$  unless otherwise specified)

Parameter	Symbol	Test Condition	Min.	Typ.	Max.	Unit
<b>Static Characteristics</b>						
Drain-Source Breakdown Voltage	$-V_{(BR)DSS}$	$V_{GS}=0V, I_D=-250\mu A$	60	--	--	V
Zero Gate Voltage Drain Current	$-I_{DSS}$	$V_{DS}=-60V, V_{GS}=0V$	--	--	1	$\mu A$
Gate-Body Leakage Current	$I_{GSS}$	$V_{GS}=\pm 20V, V_{DS}=0V$	--	--	$\pm 100$	nA
Gate Threshold Voltage <sup>Note3</sup>	$-V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=-250\mu A$	1	1.6	2.5	V
Drain-Source On-Resistance <sup>Note3</sup>	$R_{DS(on)}$	$V_{GS}=-10V, I_D=-8A$	--	52	70	m $\Omega$
		$V_{GS}=-4.5V, I_D=-8A$	--	61	90	m $\Omega$
Forward Transconductance <sup>Note3</sup>	$g_{FS}$	$V_{DS}=-5V, I_D=-2A$	--	8	--	S
<b>Dynamic Characteristics</b>						
Input Capacitance	$C_{iss}$	$V_{DS}=-20V, V_{GS}=0V, f=1\text{MHz}$	--	1100	--	pF
Output Capacitance	$C_{oss}$		--	77	--	pF
Reverse Transfer Capacitance	$C_{rss}$		--	66	--	pF
Gate Resistance	$R_g$	$V_{DS}=0V, V_{GS}=0V, f=1\text{MHz}$	--	3.6	--	$\Omega$
<b>Switching Characteristics</b>						
Turn-on Delay Time	$t_{d(on)}$	$V_{DD}=-30V, R_L=3.75\Omega$ $V_{GS}=-10V, R_{GEN}=3\Omega$	--	8	--	nS
Turn-on Rise Time	$t_r$		--	4	--	nS
Turn-off Delay Time	$t_{d(off)}$		--	32	--	nS
Turn-off Fall Time	$t_f$		--	7	--	nS
Total Gate Charge	$Q_g$	$V_{DS}=-30V, I_D=-8A, V_{GS}=-10V$	--	23.4	--	nC
Gate-Source Charge	$Q_{gs}$		--	4.1	--	nC
Gate-Drain Charge	$Q_{gd}$		--	4.8	--	nC
<b>Source-Drain Diode Characteristics</b>						
Diode Forward Voltage <sup>Note3</sup>	$-V_{SD}$	$V_{GS}=0V, I_S=-8A$	--	--	1.2	V
Diode Forward Current	$-I_S$		--	--	6	A

- Note: 1. Repetitive Rating: Pulse width limited by maximum junction temperature.  
2. Surface Mounted on FR4 Board,  $t \leq 10$  sec.  
3. Pulse Test: Pulse width  $\leq 300\mu s$ , duty cycle  $\leq 2\%$ .  
4. EAS Condition:  $T_J=25^{\circ}\text{C}$ ,  $V_{DD}=-30V, V_G=-10V, L=0.5\text{mH}, R_G=25\Omega, I_{AS}=-11A$ .

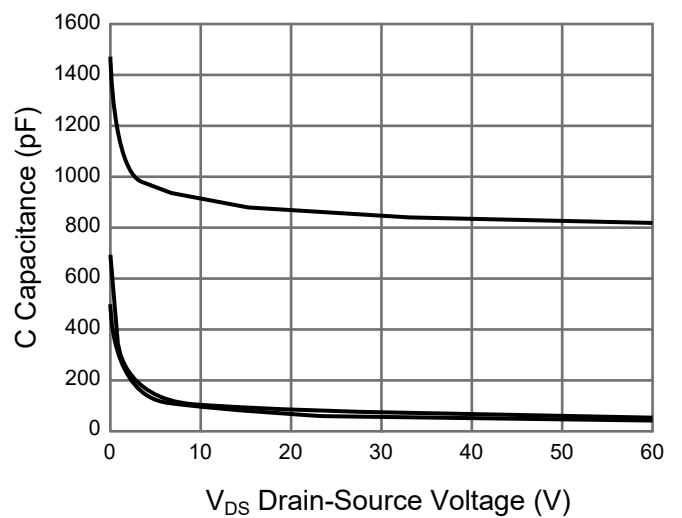
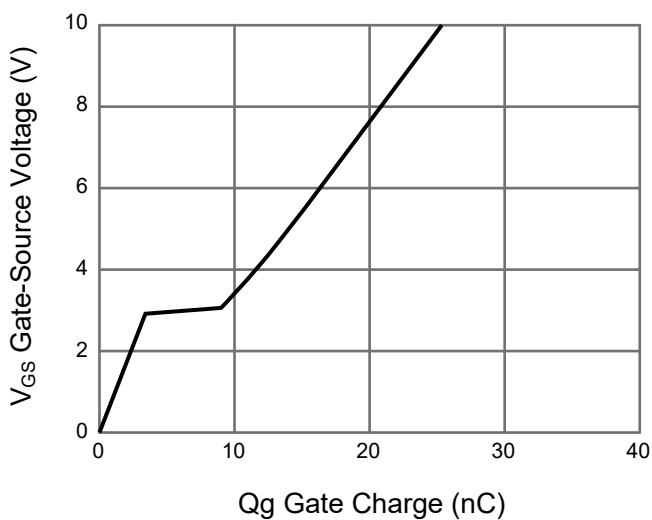
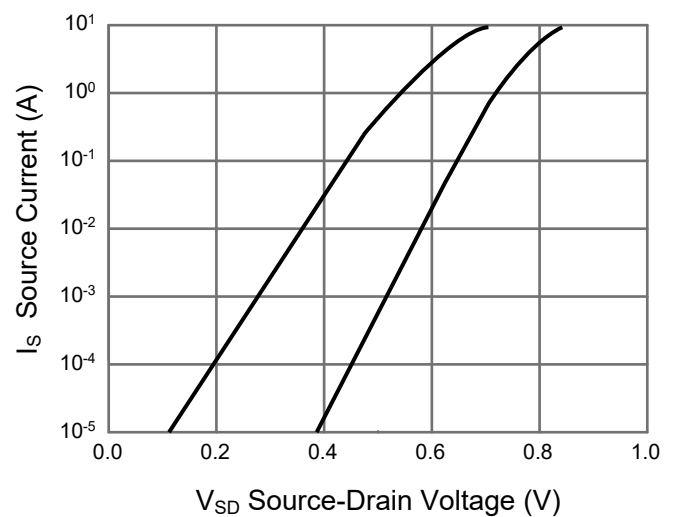
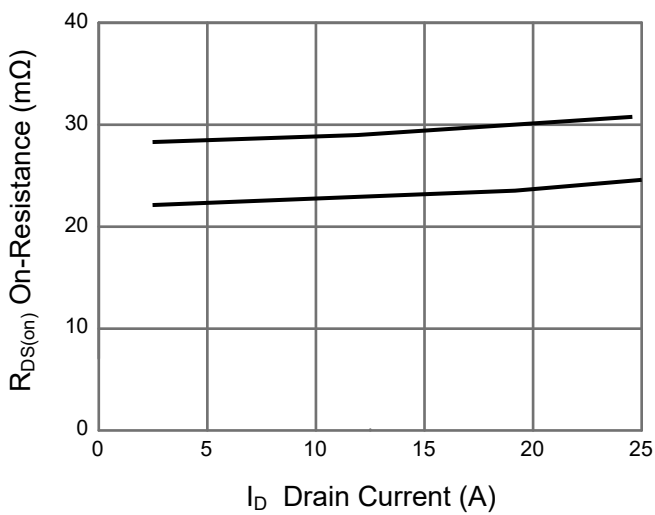
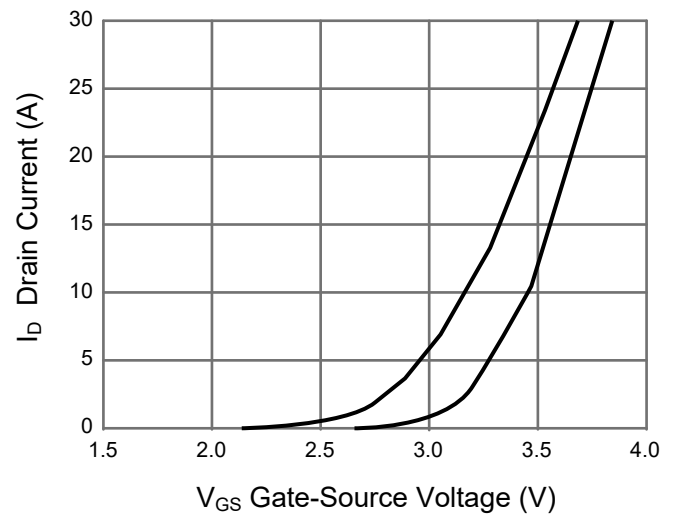
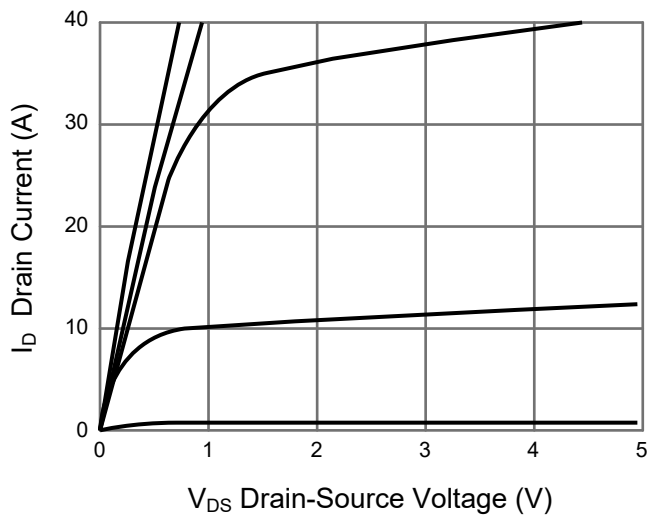


# PJM08C60PA

## N and P-Channel Complementary Power MOSFET

### N-Channel

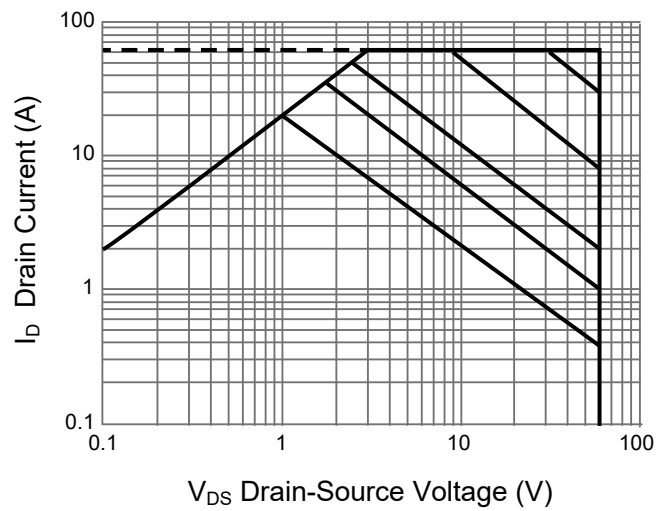
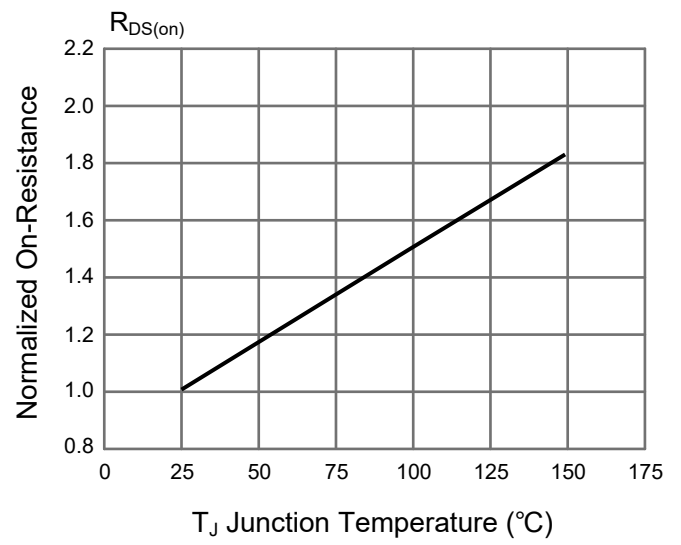
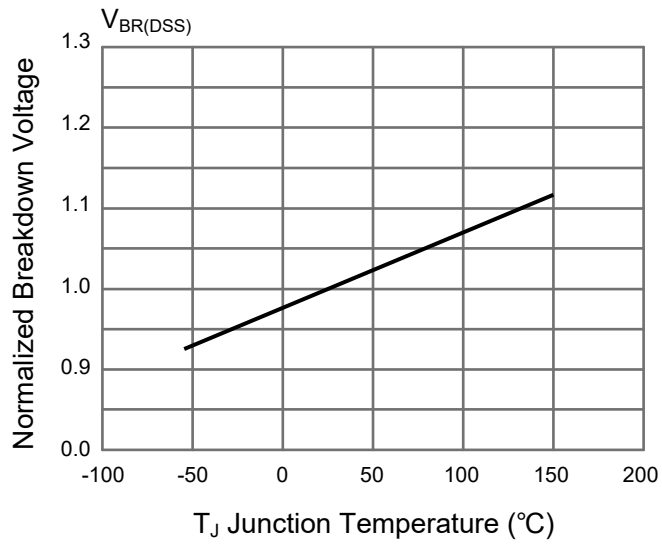
### Typical Characteristics Curves





# PJM08C60PA

## N and P-Channel Complementary Power MOSFET



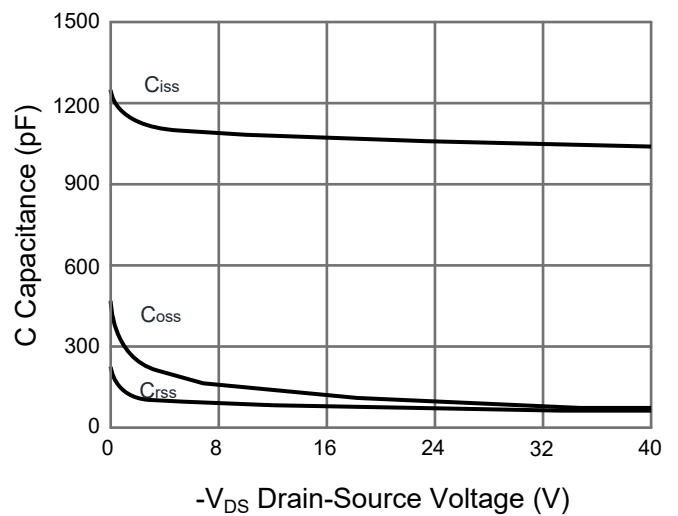
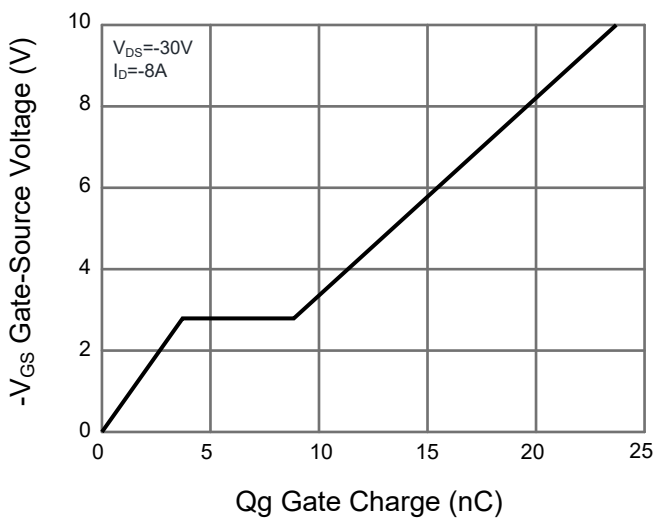
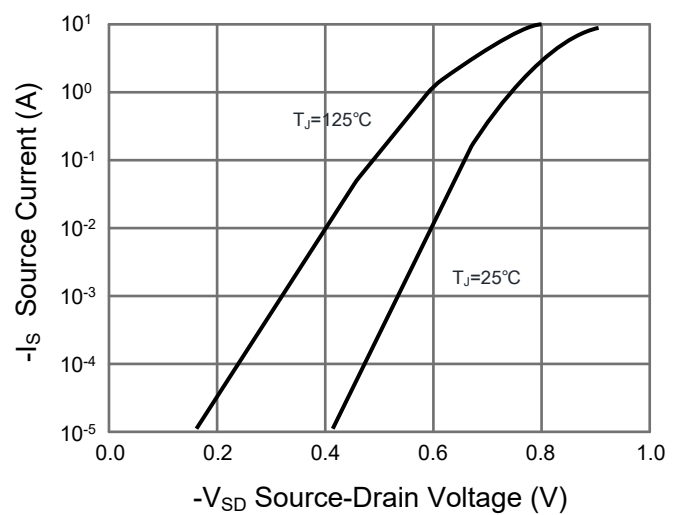
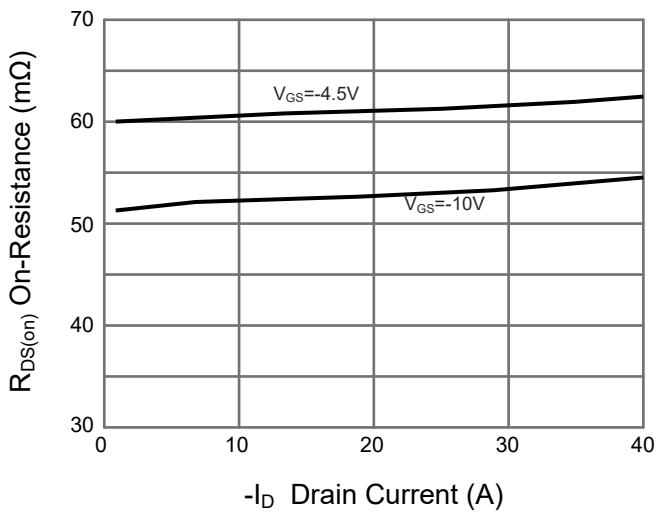
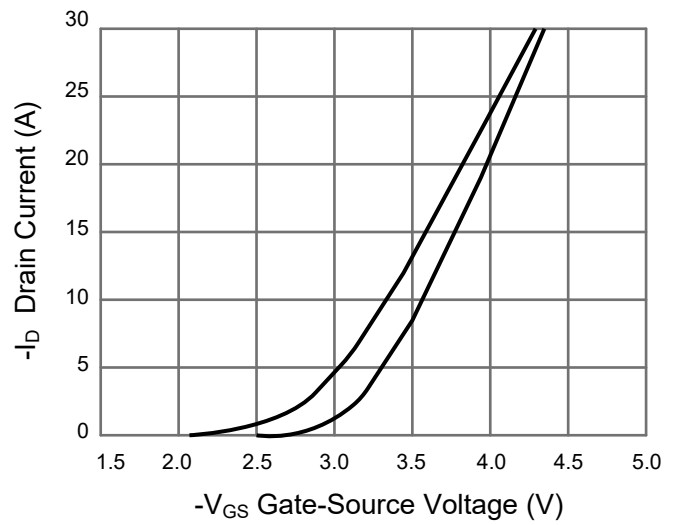
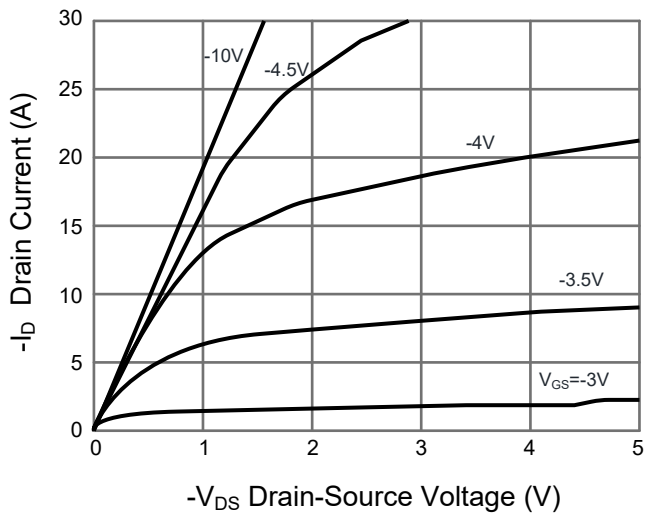


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## N and P-Channel Complementary Power MOSFET

### P-Channel

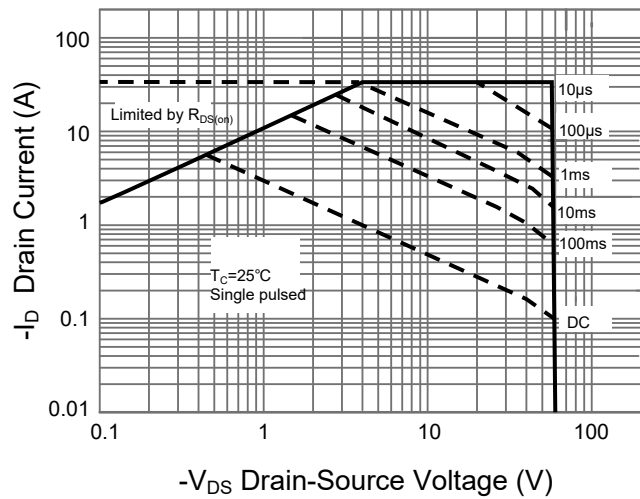
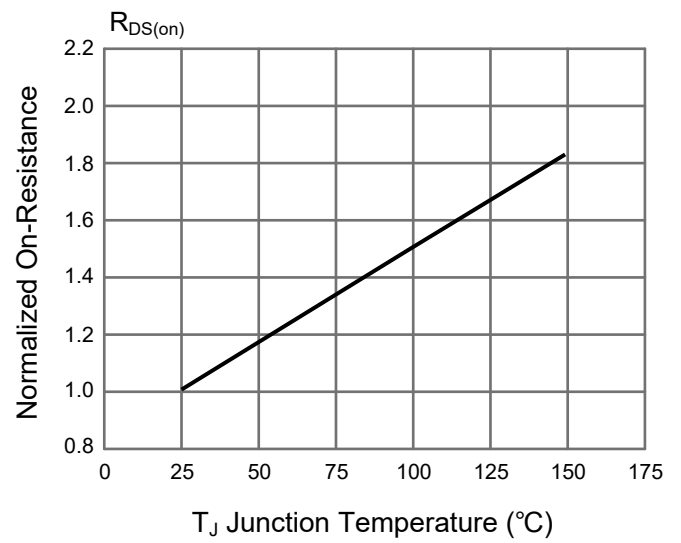
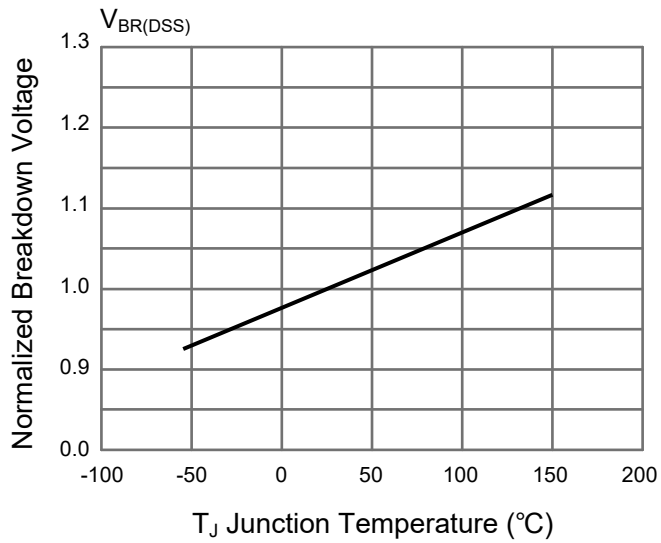
### Typical Characteristics Curves





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## N and P-Channel Complementary Power MOSFET





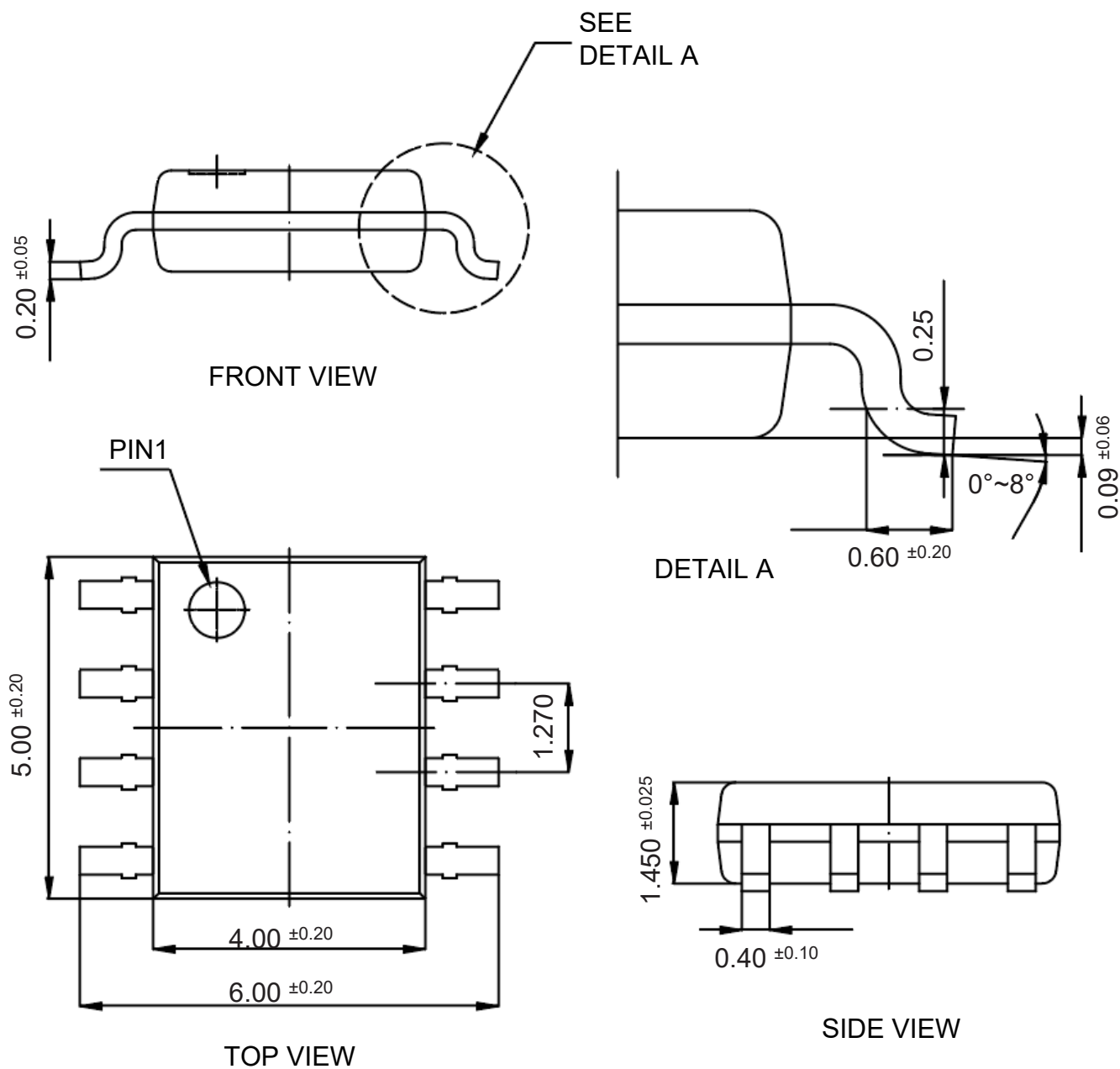
# PJM08C60PA

## N and P-Channel Complementary Power MOSFET

### Package Outline

SOP-8

Dimensions in mm



### Ordering Information

Device	Package	Shipping
PJM08C60PA	SOP-8	4,000PCS/Reel&13inches



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